TE Internal #: 1658744-3

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 4 Gb/s, EMI

Springs, SFP, 1 x 4, Through Hole - Press-Fit Mount, 4 Port, Cable-

to-Board

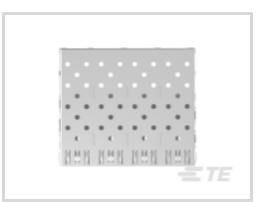
View on TE.com >



Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+











Pluggable I/O Product Type: Cage Assembly

Data Rate (Max): 4 Gb/s

EMI Containment Feature Type: EMI Springs

Pluggable I/O Applications: **SFP**

Included Lightpipe: No

Features

Product Type Features

Form Factor	SFP
Cage Type	Ganged
Pluggable I/O Product Type	Cage Assembly
Integrated Lightpipes	No
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Port Matrix Configuration	1 x 4
Port Matrix Configuration Number of Ports	1 x 4 4
Number of Ports	

Through Hole - Press-Fit

Termination Features

Termination Method to Printed Circuit Board



Mechanical Attachment

PCB Mounting Style	Through Hole - Press-Fit
Connector Mounting Type	Board Mount
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Pluggable I/O Applications	SFP
Circuit Application	Signal
Other	
EMI Containment Feature Type	EMI Springs
Included Lightpipe	No

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Compatible Parts









Customers Also Bought



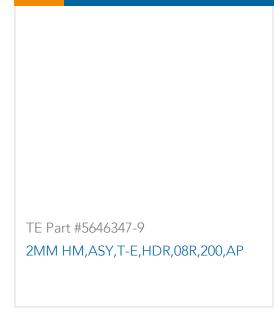












Documents

Product Drawings
SFP 1X4 CAGE ASSY

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1658744-3_F.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1658744-3_F.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1658744-3_F.3d_stp.zip

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 4 Gb/s, EMI Springs, SFP, 1 x 4, Through Hole - Press-Fit Mount, 4 Port, Cable-to-Board



English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

Product Environmental Compliance

MD_1658744-3_10212015010_dmtec

English

MD_1658744-3_10212015010_dmtec

English